Implementation of the Neumann Formula for Calculating the Mutual Inductance between Planar PCB Inductors

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Abstract - In this paper, a method for estimating the mutual inductance between two planar printed circuit board inductors with straight tracks is presented. The thin copper tracks are first modeled as multiple straight line filaments. The Neumann formula, derived from the magnetic vector potential and Faraday’s law of induction, gives an analytical solution of the mutual inductance. Unfortunately, due to the complexity of this formula, it can only be solved analytically for relatively simple geometries. However, by following the procedure presented in this paper, the mutual inductance between two arbitrary-positioned and orientated planar PCB inductors can be estimated with reduced computational effort by solving the Neumann formula using numerical integration. The proposed method is demonstrated at the hand of two experiments; and the measured and estimated mutual inductions show excellent agreement with a maximum absolute error of less than 5%.

I. INTRODUCTION

Planar inductors and transformers constructed as copper tracks on printed circuit boards (PCBs) are becoming increasingly popular in the field of contactless energy transfer (CET) and other high frequency electronic systems [2]-[5], [9].

In the case of CET, electronic devices embedded with PCB inductors of various shapes and sizes, transfer power through their shared magnetic field and the inductive coupling between them.

When these inductors (often in the shape of spirals) are excited with relatively low frequency current waveforms, the system is said to operate in a magneto-static mode where the magnetic fields created by these inductors can be approximated by static magnetic fields. With the lack of soft magnetic materials, these fields can be accurately described by the Maxwell equations [1].

The mutual inductance between two inductors is a measure of their magnetic coupling and the amount of shared magnetic field between them. In the CET systems, estimating the mutual inductance between the primary and secondary inductors is vital in determining the capability and efficiency of the power transfer between the devices.

Unfortunately, due to all the different shapes and forms these inductors may take, no straightforward method for calculating their mutual inductances exists.

One existing method for estimating the mutual inductance between such inductors is the finite element method (FEM). This numerical technique approximates the mutual inductance by modeling the inductors in a three-dimensional environment and solving the electromagnetic field equations in and around the devices. Using this purely numerical method, can however be very time consuming especially when complex structures are simulated.

Some papers exist, describing analytical and semi-analytical methods for estimating the mutual inductance between circular conductors. In these papers, the thin conductors are modeled as single current filaments, and thicker conductors as groups of filaments, often called the mesh-matrix method [6], [7], [10], [11].

Unfortunately, in the case of the hexagonal spiral windings (Fig. 1), which are quite attractive in practical applications as used in [2] and [3], the tracks are not circular but consist of multiple straight line segments. A different approach is thus needed for calculating the mutual inductance between these- and other planar PCB inductors with straight tracks.

The problem addressed in this paper is that of developing a method for estimating the mutual inductance between planar PCB inductors with straight tracks.

Firstly, the copper tracks of the planar PCB inductors are modeled as multiple straight line filaments. Secondly, various filament parameters are extracted from the model, e.g. the amount of filaments, the amount of filament vertices as well as their three-dimensional coordinates.

Fig. 1. A planar hexagon spiral winding used in contactless energy transfer applications.
Finally, the mutual inductance is approximated by implementing a numerical representation of the Neumann formula as an algorithm in a computer program. The presented method is demonstrated by means of two experiments. In the first experiment, the mutual inductance between two planar hexagon spiral windings used in [2], is estimated. The mutual inductance is first calculated for different relative winding placements, and afterwards measured using the actual PCB windings. In the second experiment, a high frequency planar PCB current transformer is designed. For a certain primary current and required secondary no-load voltage, the desired mutual inductance is first estimated. With the primary winding as a straight track and the secondary winding as a planar rectangular spiral winding, the transformer is realized.

In both experiments the measured and estimated mutual inductances show excellent agreement with a maximum absolute error of less than 5%.

II. PCB FILAMENT MODEL

The copper tracks of the PCB inductors are modeled as current filaments, where each straight line segment is modeled by a filament, placed at the center of the track, as show in Fig. 2.

Fig. 2. (a) A square PCB spiral inductor with two turns, (b) with the copper tracks modeled as current filaments.

III. ANALYTICAL SOLUTION

The analytical solution for calculating the mutual inductance between two multi-filament structures is derived using the magnetic vector potential. With the lack of soft magnetic material, and assuming a magneto-static regime, the magnetic vector potential produced by a line current in a filamentary structure is expressed as

\[ A(r) = \frac{\mu I}{4\pi} \int \frac{dl}{|r - r'|}, \]  \hspace{1cm} (1)

where, as illustrated in Fig. 3, \( P \) is the observation point, \( r \) is the vector pointing from the axis origin to the observation point, \( l \) is the primary filamentary structure contour, \( r' \) is the vector pointing from the axis origin to the structure contour, \( dl \) is the infinitesimally small integration element on the contour path, and \( I \) is the total current through the structure.

The magnetic field relates to the magnetic vector potential though the curl operator, and can be expressed by

\[ B = \nabla \times A. \]  \hspace{1cm} (2)

The magnetic flux linking two filamentary structures can be calculated by integrating the magnetic field produced by the current in the primary structure defined by its contour \( l \), through the surface of the secondary structure bounded by its contour \( k \). The flux linkage between the two is given as

\[ \lambda(l, k) = \int B \cdot da_k, \]  \hspace{1cm} (3)

where \( B \) represents the magnetic flux density created by the primary structure on \( da_k \), a surface element on the secondary structure. Using Stokes theorem [1], the surface integral in (3) is converted into a contour integral so that it becomes

\[ \lambda(l, k) = \oint A \cdot dk. \]  \hspace{1cm} (4)

Combining (1) and (4), the following expression for the flux linkage between the two filamentary structures is formulated as

\[ \lambda(l, k) = \frac{\mu I}{4\pi} \oint \frac{dl \cdot dk}{|r - r'|}. \]  \hspace{1cm} (5)

Here, as shown in Fig. 4, \( l \) and \( k \) are the contours of the primary and secondary filamentary structures, respectively, \( dl \) and \( dk \) are infinitesimally small integration elements.
The mutual inductance between the two filamentary structures is then calculated as:

\[ M(l,k) = \lambda(l,k) / I. \]  

Formula (5) is also known as the Neumann formula [8]. The integral can unfortunately only be completed analytically for relatively few configurations.

IV. NUMERICAL SOLUTION

Since an analytical solution of (5) is in general quite impractical, numerical integration can be used to approximate it by evaluating the integrand in very small increments. The advantage of using the numerical integration as proposed in this section is that the definite integral in (5) can be implemented with low computational effort to evaluate arbitrary positioned and orientated filamentary structures. The procedure for implementing the numerical integration is shown in the next seven steps:

1. The total amount of straight line segments on the primary filament contour, \( l \), and the secondary filament contour, \( k \), is determined. They are stored as \( a' \) and \( a'' \), respectively.
2. The total amount of vertices (including the start and stop positions) on the primary and secondary structures are determined. They are stored as \( b' \), where \( b' = a' + 1 \), and \( b'' \), where \( b'' = a'' + 1 \), respectively.
3. The three-dimensional coordinates of the primary- and secondary vertices are determined and stored in vectors \( q' \) and \( q'' \), respectively.
4. The Euclidean lengths of all the primary and secondary filaments are then calculated and stored in the arrays \( c' \) and \( c'' \), respectively.
5. The normalized filament vectors are calculated as:

\[ n'_m = \frac{q'_m - q'_n}{c'_m}, m \in [1...a'] \]  

Here, \( n' \) represents the normalized position vectors for the primary structure filaments. Similarly, the normalized position vectors for the secondary filaments can be calculated and is represented as \( n'' \). The subscript \( m \) denotes the appropriate filament.
6. The flux linkage between the primary and secondary structures is then estimated as:

\[ \lambda'(l,k) = \frac{\mu I \Delta_\alpha \Delta_\beta}{4\pi} \sum_{a=1}^{a'} \sum_{g=1}^{c'} \sum_{n=1}^{X} \sum_{m=1}^{Y} \frac{n'_m \cdot n''_n}{|K_g - K_n|} \]  

where

\[ K_g = q'_e + (\chi(\Delta_\alpha) \cdot n'_e), \]

\[ K_n = q''_e + (\epsilon(\Delta_\beta) \cdot n''_e), \]

\[ X = c'_e / \Delta_\alpha, \quad E = c''_e / \Delta_\beta. \]

Here, the lengths \( \Delta_\alpha \) and \( \Delta_\beta \) are small numerical integration elements.
7. Finally, the mutual inductance between the two filaments can then be estimated from (6) as:

\[ M'(l,k) = \lambda'(l,k) / I. \]

Caution must be taken when choosing the values for \( \Delta_\alpha \) and \( \Delta_\beta \). On the one hand, choosing these values too small will increase the accuracy of the model but also increase the processing time needed to solve the numerical integral. On the other hand, choosing these values too big reduces the model accuracy. By iterating (8) with decreasing values of \( \Delta_\alpha \) and \( \Delta_\beta \), the convergence of the resultant mutual inductance can be used as a gauge in determining the accuracy of the model. Generally, these values should be about the same order of magnitude (preferably smaller) than the PCB track thickness and track spacing.

V. EXPERIMENTAL VALIDATION

The method for estimating the mutual inductance proposed in this paper is demonstrated at the hand of two experiments. In these experiments no soft magnetic material is present, a magneto-static regime is assumed, and all current and voltage calculations and measurements are sinusoidal steady state waveforms. In both cases the mutual inductances are measured by exciting the primary winding with a current waveform and measuring the no-load secondary induced voltage. Assuming no (or negligible) secondary current, the mutual inductance is
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estimated using:

$$|V|^2 = j\omega |I_1| M_{12}.$$  (10)

Here $I_1$ is the current amplitude and $\omega$ is the radial frequency of the primary current; $V_2$ is the secondary induced voltage and $M_{12}$ is the mutual inductance between the primary and secondary winding.

A. Hexagon spiral winding mutual inductance

In [2], a contactless energy transfer (CET) platform is presented. In this system, power is transferred from a primary CET platform embedded with a matrix hexagon spiral windings to secondary devices (e.g. mobile phones, PDAs and laptops) embedded with similar receiving windings, through inductive coupling.

Accurate estimation of the mutual inductance between the primary and secondary windings are vital in developing the power electronics circuits required to power the system, and determining the systems’ capabilities as a whole. The physical dimensions of the primary and secondary hexagon spiral windings are specified in Table I.

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Primary Winding Value</th>
<th>Secondary Winding Value</th>
</tr>
</thead>
<tbody>
<tr>
<td>Radius</td>
<td>12 mm</td>
<td>20 mm</td>
</tr>
<tr>
<td>Turns</td>
<td>13</td>
<td>23</td>
</tr>
<tr>
<td>Thickness</td>
<td>105 µm</td>
<td>105 µm</td>
</tr>
<tr>
<td>Track width</td>
<td>0.5 mm</td>
<td>0.5 mm</td>
</tr>
<tr>
<td>Track spacing</td>
<td>0.25 mm</td>
<td>0.25 mm</td>
</tr>
</tbody>
</table>

Using the techniques described in this paper, the mutual inductance between a single primary winding and a single secondary winding is first calculated and then measured. With, $\Delta_y = \Delta_z = 0.5$ mm, the primary winding is kept at the axis origin, the secondary winding is shifted parallel to the primary at different $x$-, $y$-, and $z$-coordinates, as shown in Fig. 5.

![Fig. 5. The position of the primary- and secondary hexagon spiral windings during mutual inductance calculation and measurements.](image)

Fig. 6 shows part of the setup used to measure the mutual inductance. Here the secondary hexagon spiral winding is placed on top of a matrix of hexagon spiral windings. The activated primary winding is hidden underneath the secondary winding. White plastic spacers are used to separate the windings. The current probe, measuring the primary current, and voltage probe, measuring the secondary induced voltage, can also be seen.

<table>
<thead>
<tr>
<th>Secondary winding position $(x, y, z)$ [mm]</th>
<th>Calculated Mutual Inductance</th>
<th>Measured Mutual Inductance</th>
<th>Error</th>
</tr>
</thead>
<tbody>
<tr>
<td>0, 0, 2</td>
<td>3.20 µH</td>
<td>3.16 µH</td>
<td>-1.27 %</td>
</tr>
<tr>
<td>0, 0, 3</td>
<td>2.75 µH</td>
<td>2.64 µH</td>
<td>-4.17 %</td>
</tr>
<tr>
<td>0, 0, 4</td>
<td>2.37 µH</td>
<td>2.35 µH</td>
<td>-0.85 %</td>
</tr>
<tr>
<td>0, 0, 5</td>
<td>2.05 µH</td>
<td>2.01 µH</td>
<td>-1.99 %</td>
</tr>
<tr>
<td>10.4, 0, 2</td>
<td>1.40 µH</td>
<td>1.43 µH</td>
<td>2.10 %</td>
</tr>
<tr>
<td>10.4, 0, 3</td>
<td>1.25 µH</td>
<td>1.29 µH</td>
<td>3.10 %</td>
</tr>
<tr>
<td>10.4, 0, 4</td>
<td>1.11 µH</td>
<td>1.15 µH</td>
<td>3.48 %</td>
</tr>
<tr>
<td>10.4, 0, 5</td>
<td>1.00 µH</td>
<td>1.03 µH</td>
<td>2.91 %</td>
</tr>
<tr>
<td>12, 0, 2</td>
<td>900 nH</td>
<td>916 nH</td>
<td>1.75 %</td>
</tr>
<tr>
<td>12, 0, 3</td>
<td>826 nH</td>
<td>802 nH</td>
<td>-3.00 %</td>
</tr>
<tr>
<td>12, 0, 4</td>
<td>760 nH</td>
<td>751 nH</td>
<td>-1.20 %</td>
</tr>
<tr>
<td>12, 0, 5</td>
<td>700 nH</td>
<td>716 nH</td>
<td>2.23 %</td>
</tr>
</tbody>
</table>

B. High frequency planar current transformer

In order to control the power transfer in the CET system presented in [2], the controller needs to measure the current through each activated primary hexagon spiral winding. To do this, a high frequency current transformer is implemented as copper traces on a PCB. The primary winding is a straight
track (to minimize the introduced inductance) placed in the current path, and the induced voltage over the secondary winding is sampled and measured by the controller using a high speed analog-to-digital converter (ADC). The ADC has an extremely large input resistance (5-20 kΩ) and the secondary current is assumed to be zero.

For a current frequency of 2.7 MHz, a secondary induced voltage of 1 V (rms) per 1 A (rms) of primary current is required. The necessary mutual inductance is estimated as 57.31 nH. The general shape of the transformer is shown in Fig. 7, and the physical dimensions are determined through a parametric search through the variables shown in the figure. Values of $\Delta_l$ and $\Delta_k$ equal to 1 mm are used.

![Fig. 7. The planar PCB transformer model.](image)

The physical dimensions of the developed PCB transformer are presented in Table III.

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Value</th>
</tr>
</thead>
<tbody>
<tr>
<td>$H_1$</td>
<td>5 mm</td>
</tr>
<tr>
<td>$H_2$</td>
<td>40 mm</td>
</tr>
<tr>
<td>$W_1$</td>
<td>3 mm</td>
</tr>
<tr>
<td>$W_2$</td>
<td>42 mm</td>
</tr>
<tr>
<td>$W_3$</td>
<td>5 mm</td>
</tr>
</tbody>
</table>

The implemented PCB transformer has a track thickness of 1 mm and copper thickness of 35 µm, and is shown in Fig. 8.

![Fig. 8. The actual planar PCB current transformer.](image)

The mutual inductance is measured as 56.10 nH, which gives an error of approximately -2.5%.

VI. CONCLUSIONS

In this paper, a method for estimating the mutual inductance between PCB inductors with straight tracks is presented.

The copper tracks of the PCB inductors are first modeled as multiple straight line filaments of which various parameters are then extracted (e.g. the amount of filaments, the amount of filament vertices as well as their three-dimensional coordinates). The mutual inductance is then approximated by implementing a numerical representation of the Neumann formula as an algorithm in a computer program.

The presented method is demonstrated by means of two experiments. In the first experiment, the mutual inductance between two planar hexagon spiral winding used in a CET system [2], is estimated. The mutual inductance is first calculated and afterwards measured using the actual PCB windings, for different relative winding placements. In the second experiment, a high frequency planar PCB current transformer is designed. For a certain primary current and required secondary no-load voltage, the desired mutual inductance is first estimated. With the primary winding as a straight track and the secondary winding as a planar rectangular spiral winding, the transformer is realized.

In both experiments the measured and estimated mutual inductances show excellent agreement with a maximum absolute error of less than 5%.

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